



Features

- ESD Protect for Low-Voltage Differential Signaling (LVDS) channels
- Protects four I/O lines
- Provide ESD protection for each line to
IEC 61000-4-2 (ESD) $\pm 30\text{kV}$ (air), $\pm 25\text{kV}$ (contact)
IEC 61000-4-4 (EFT) 80A (5/50ns)
IEC 61000-4-5 (Lightning) 15A (8/20 μs)
- **For operating voltage of 3.3V and below**
- **Low capacitance : 2.0pF typical**
- Fast turn-on and Low clamping voltage
- Array of ESD rated diodes with internal equivalent TVS (Transient Voltage Suppression) diode
- Solid-state silicon-avalanche and active circuit triggering technology
- **Green part**

Applications

- LVDS Interface
- USB2.0 Data lines protection
- Control Signal Lines Protection
- SIM ports
- Monitors and Flat Panel Displays
- Notebook and PC Computers
- Ethernet port: 10/100/1000 Mb/s
- Consumer Electronics
- Set Top Box

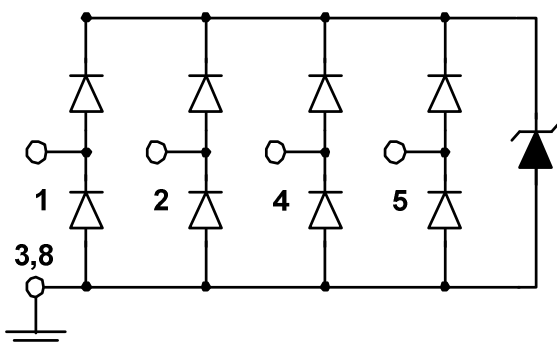
Description

AZ1013-04F is a high performance design which includes surge rated diode arrays to protect high speed data interfaces. The AZ1013-04F has been specifically designed to protect sensitive components, which are connected to data and transmission lines, from over-voltage caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), and Lightning.

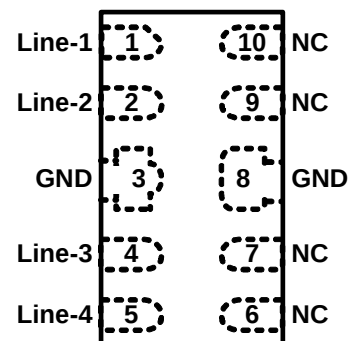
AZ1013-04F is a unique design which includes surge rated, low capacitance steering diodes and a unique design of clamping cell which is an equivalent TVS diode in a single package. During transient conditions, the steering diodes direct the transient to either the internal ESD line or to ground line. The internal unique design of clamping cell prevents over-voltage on the internal ESD line and on the I/O line, which is protecting any downstream components.

AZ1013-04F may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ($\pm 15\text{kV}$ air, $\pm 8\text{kV}$ contact discharge).

Circuit Diagram



Pin Configuration



DFN2510P10E (Top View)

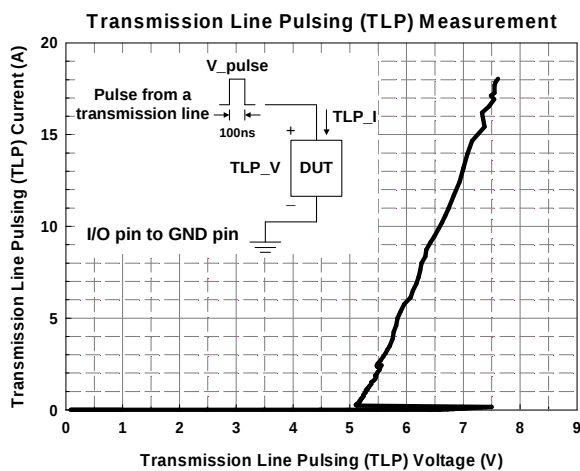
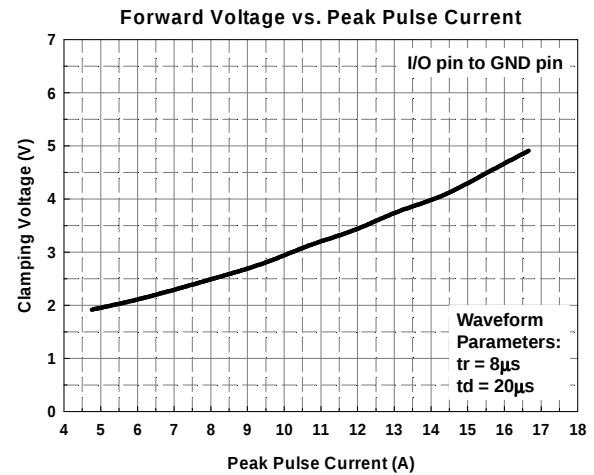
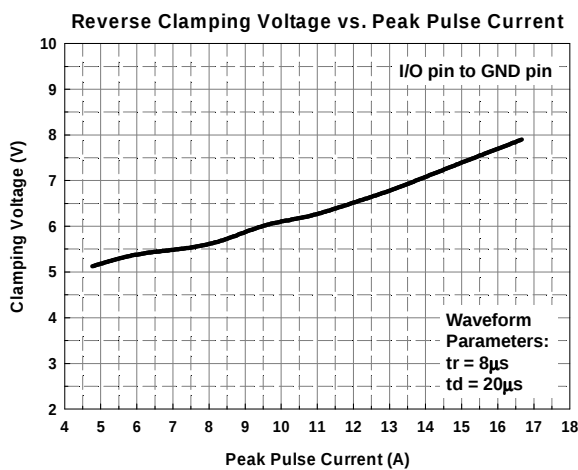
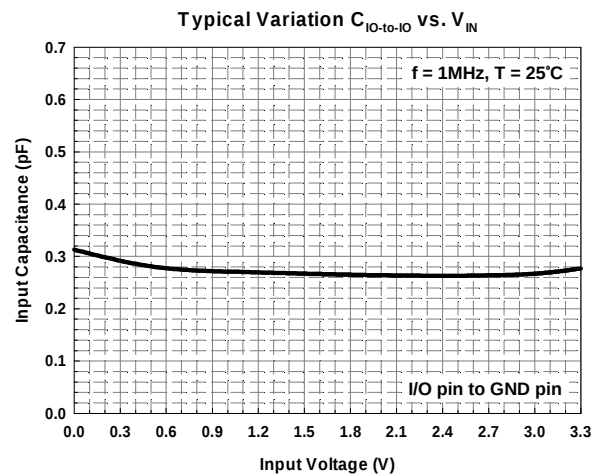
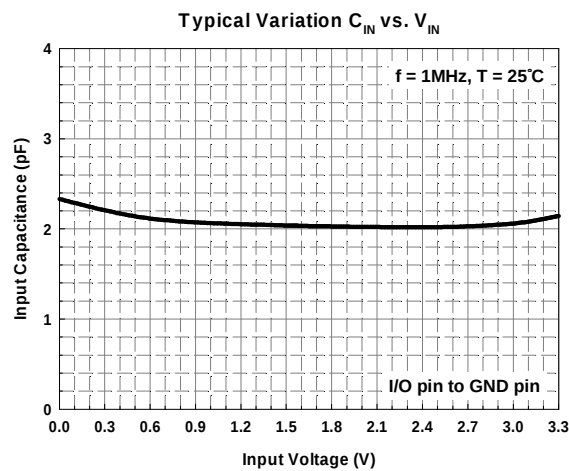
SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS			
PARAMETER	SYMBOL	RATING	UNITS
Peak Pulse Current (tp =8/20μs)	I _{PP}	15	A
Operating Voltage (I/O pin-GND)	V _{DC}	(GND – 0.5) to 3.6	V
ESD per IEC 61000-4-2 (Air)	V _{ESD}	30	kV
ESD per IEC 61000-4-2 (Contact)		25	
Lead Soldering Temperature	T _{SOL}	260 (10 sec.)	°C
Operating Temperature	T _{OP}	-55 to +85	°C
Storage Temperature	T _{STO}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Reverse Stand-Off Voltage	V _{RWM}	Pin-1,-2,-4,-5 to pin-3,-8, T=25 °C			3.3	V
Channel Leakage Current	I _{CH-Leak}	V _{Pin-1,-2,-4,-5} = 3.3V, V _{Pin-3,-8} = 0V, T=25 °C			1	μA
Reverse Breakdown Voltage	V _{BV}	I _{BV} = 1mA, T=25 °C, Pin-1,-2,-4,-5 to pin-3,-8	4.5			V
Forward Voltage	V _F	I _F = 15mA, T=25 °C, pin-3,-8 to pin-1,-2,-4,-5		0.9	1.2	V
ESD Clamping Voltage	V _{clamp}	IEC 61000-4-2 +6kV, T=25 °C, Contact mode, any I/O pin to Ground		7.8		V
ESD Dynamic Turn-on Resistance	R _{dynamic}	IEC 61000-4-2, 0~+6kV, T=25 °C, Contact mode, any I/O pin to Ground		0.14		Ω
Lightning Clamping Voltage	V _{lightning}	I _{PP} =5A, tp=8/20μs, T=25 °C Any Channel pin to Ground		5.2		V
Channel Input Capacitance	C _{IN}	V _{pin-3,-8} = 0V, V _{IN} = 1.65V, f = 1MHz, T=25 °C, any I/O pin to Ground		2.0	2.5	pF
Channel to Channel Input Capacitance	C _{CROSS}	V _{pin-3,-8} = 0V, V _{IN} = 1.65V, f = 1MHz, T=25 °C, between I/O pins		0.25	0.5	pF

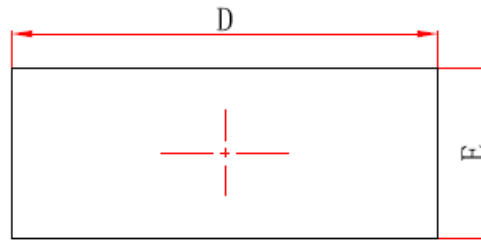


Typical Characteristics

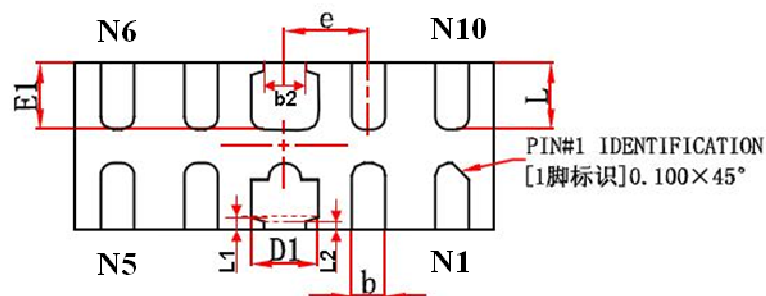




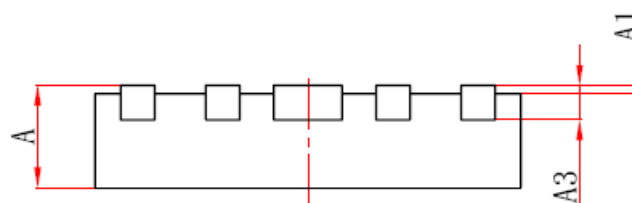
PACKAGE OUTLINE (DFN2510P10E)



TOP VIEW (unit in mm)



BOTTOM VIEW (unit in mm)

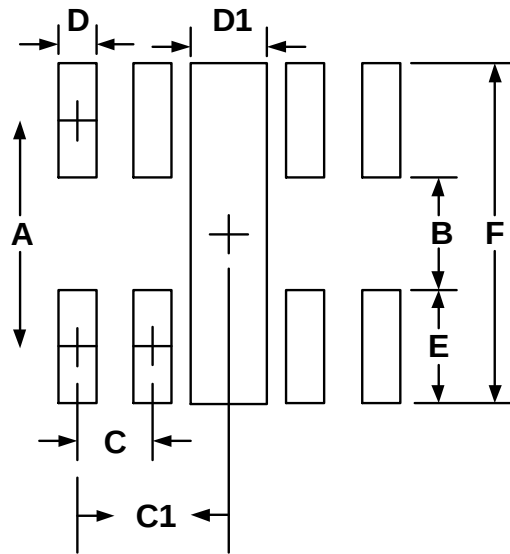


SIDE VIEW (unit in mm)

Symbol	Millimeters		Inches	
	min	max	min	max
A	0.40	0.55	0.016	0.022
A1	0.00	0.05	0.000	0.002
A3	0.152REF.		0.006 BSC	
D	2.45	2.55	0.096	0.100
E	0.95	1.05	0.037	0.041
D1	0.35	0.45	0.014	0.018
E1	0.35	0.45	0.014	0.018
b	0.15	0.25	0.006	0.010
e	0.5 BSC		0.019 BSC	
L1	0.075 REF		0.0029 REF	
L2	0.05 REF		0.0019 REF	
b2	0.20	0.30	0.0079	0.012
L	0.35	0.45	0.014	0.018



LAND LAYOUT



Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

Dimensions		
Index	Millimeter	Inches
A	0.875	0.034
B	0.20	0.008
C	0.50	0.02
C1	1.00	0.039
D	0.25	0.01
D1	0.4	0.016
E	0.675	0.027
F	1.55	0.061

MARKING CODE



153 = Device Code
X = Date Code
Y = Control Code

Part Number	Marking Code
AZ1013-04F (Green Part)	153XY

Note. Green means Pb-free, RoHS, and Halogen free compliant.

Ordering Information

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ1013-04F.R7G	Green	T/R	7 inch	3,000/reel	4 reel= 12,000/box	6 box =72,000/carton



Revision History

Revision	Modification Description
Revision 2014/07/30	Preliminary Release.
Revision 2014/11/20	Formal Release.